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March 2015

DFB20100F162 Glass-Passivated Bridge Rectifier

Features

- UL Certificate: # E258596
- · Glass-Passivated Junction
- · Ideal for Printed Circuit Board
- · Reliable Low-Cost Construction
- Plastic Material has Underwriters Laboratory Flammability Classifica. 194 0
- Surge Overload Rating to 250 A Peak
- High Case Dielectric Strength: 2000 V_{RMS}
- Isolated Voltage from Case to Lead: > 2500 V



Forr in a TS-6P

Ordering Information

Part Number	Tor Mark Package	Packing Method
DFB20100F162	DFB20100 TS-Si 4L	Bulk

A' 'un Ma ' am Faiings(1), (2).

resses above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, and exposure to stress above the recommended operating conditions may affect device reliability. The absolute maxim um ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{RRM}	Maximum Pecurrent Peak Reverse Voltage	1000	V
V _{RMS}	Maximun RMS Voltage	700	V
V _{DC}	Maximum DC Blocking Voltage	1000	V
I _{F(AV)}	Maximum Average Forward Rectified Current	20	Α
I _{FSM}	Peak Forward Surge Current (8.3 ms Single Half-Wave)	250	Α
$R_{\theta JC}$	Typical Thermal Resistance ⁽²⁾	4.75	°C/W
T _J	Operating Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

Notes:

- 1. Single-phase, half-wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.
- 2. Device mounted on 4 inch x 5 inch x 0.25 inch Al-plate heat sink.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Value	Unit
V _F	Maximum Instantaneous Forward Voltage	I _F = 10 A	1.0	V
		I _F = 20 A	1.1	
I _R	Maximum DC Reverse Current at Rated DC Blocking Voltage	$T_A = 25^{\circ}C$	10	μΑ
		T _A = 125°C	500	
I ² t	Rating for Fusing (t < 8.3 ms)		259	A ² s
CJ	Typical Junction Capacitance per Le	140	pF	

Note:

3. Measured at 1 MHz and applied reverse bias of 4.0 V DC.

Typical Performance Characteristics

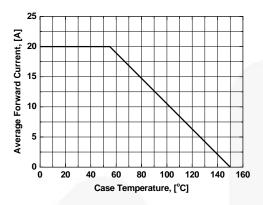


Figure 1. Maximum Derating Curve for Output Current

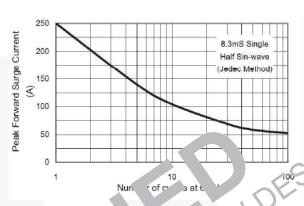
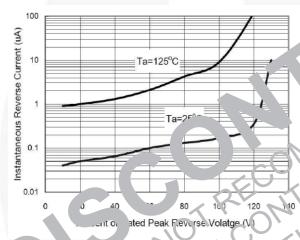


Figure 2. Maximum orw 15' Je Current per Leg



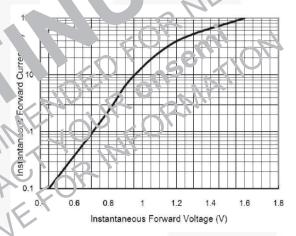


Figure 4. Typical Forward Characteristics per Leg

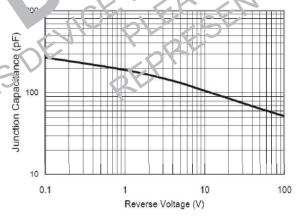
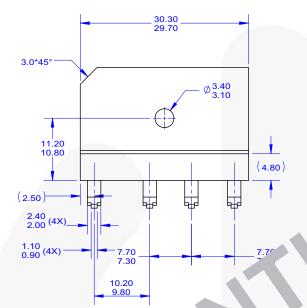
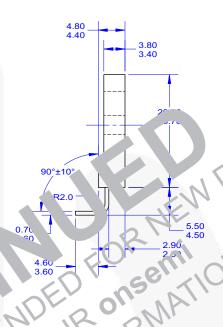


Figure 5. Typical Junction Capacitance

Physical Dimensions





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A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDAR IS.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MC/LD FLASH AND TIE BAR PROTRUSIONS.

D. DRAWING FILE NAME: TS6P04BREV1



Figure 6 + LEAD, TSAP, THROUGH-HOLE, MOLDED PACKAGE



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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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Rev. 173



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